

Material Composition Declaration

© Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.

This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

1752-2 1.1

ICP Web Site for information on IPC-1752 Standard
<http://www.ipc.org/IPC-175x>

Form Type*
 Distribute

Declaration Class*

Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information

Supplier Information

Company Name * Fairchild Semiconductor	Company Unique ID 00-489-5751	Unique ID Authority Dun & Bradstreet	Response Date* Sat, Jun 16, 2012 01:53 AM
Contact Name * David Lancaster	Title - Contact Product Ecology	Phone - Contact * 801-562-7455	Email - Contact * david.lancaster@fairchildsemi.com
Authorized Representative * David Lancaster	Title - Representative Product Ecology	Phone - Representative * 801-562-7455	Email - Representative * david.lancaster@fairchildsemi.com

Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufacturing Site	Weight*	UOM	Unit Type
3N246	3N246	KBPM			SUBCONTRACTOR	1.764	g	Each

Manufacturing Process Information

Terminal Finish	Base Alloy	J-STD-020 MSL Rating	Peak Process Body Temperature	Max Time at Peak Temperature	No Reflow cycles
Matte Tin (Sn)	CU Alloy	Not Applicable	C	seconds	Not Applicable

* Required Field

RoHS Material Composition Declaration		Declaration Type * Custom
RoHS Directive 2002/95/EC	RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium	
Providing for limitations below, we certify that the Fairchild Semiconductor product(s) list in this document are compliant to directive 2002/95/EC of the European Parliament and of the council on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS directive). Specifically, this product(s) does not contain the substances in the RoHS definition above in concentrations greater than the maximum limit value(a). Fairchild has implemented procedures to ensure our products and the materials in our products conform to regulatory requirements worldwide. Fairchild Semiconductor certifies that the information provided in this document is correct as of the date indicated on this document. However, not all materials in Fairchild's products may have been independently verified or tested with regard to substance content. In the event of any issues arising from information in this document, the warranty section of Fairchild's standard terms and conditions of sale shall apply, unless alternate contracts have been agreed upon in writing by both parties. (a) Maximum limit does not apply to applications for which exemptions have been granted by the RoHS directive. Fairchild product may utilize exemption 5 and 7a.		
RoHS Declaration *	4 - Item(s) does not contain RoHS restricted substances per the definition above except for selected exemptions	Supplier Acceptance * Accepted
Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. Exemption List Version EL-2006/690/EC 7a. Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85 % by weight or more lead).		
Declaration Signature		
Supplier Signature	 DAVID LANCASTER - PRODUCT ECOLOGY MANAGER	

Homogeneous Material Composition Declaration for Electronic Products

Item/SubItem Name KBPM

Component	Material	Weight (mg)	Jig Level	Substance Category	Substance	Weight (mg)	CAS	PPM
Chip	Other inorganic materials	7.600	Supplier		Silicon	7.600	7440-21-3	4309
Die Attach	Other Nonferrous metals & alloys	17.517	A	Lead/Lead Compounds	Lead	16.200	7439-92-1	9185
			Supplier		Silver	0.439	7440-22-4	249
			Supplier		Tin	0.878	7440-31-5	498
Encapsulation	Thermoplastics	1050.000	B	Antimony/Antimony Compounds	Antimony Trioxide	20.000	1309-64-4	11339
			B	Brominated Flame Retardants (other than PBCs or PBDEs)	Bromine Resin	30.000	6386-73-8	17009
			Supplier		Epoxy Resin	190.000	29690-82-2	107725
			Supplier		Silica, vitreous	810.000	60676-86-0	459247
Lead Frame	Other Ferrous alloys, non-stainless steels	681.361	Supplier		Copper	680.000	7440-50-8	385540
			Supplier		Iron	1.020	7439-89-6	578
			Supplier		Phosphorus	0.341	7723-14-0	193
Plating	Other Nonferrous metals & alloys	7.280	Supplier		Tin	7.280	7440-31-5	4128